Heraeus

Technical Data Sheet



THICK FILM MATERIALS

Product Type: Conductors

Product Name: C2220



Silver / Palladium Conductor Paste

Description

C2220 is a lead free 2.1 : 1 Ag / Pd conductor paste which exhibits high density, high reliability and good fine line definition.

It fires to a smooth surface and is mechanically durable and chemically resistant. Due to these characteristic C2220 is a recommended material for application such as fuel sensors.

Key Benefits

- Excellent conductivity, leach resistance and resistance to silver migration
- Free of lead, cadmium, nickel and phthalate

Typical Properties (Paste)

Form Pseudoplastic paste

Viscosity 30 – 50 Pas

 $(25 \, ^{\circ}\text{C}, \, D = 100/\text{s})$

Solids $84.5 \% \pm 1.5 \%$

Printing Speed Up to 20 cm/s

Shelf Life 6 months from date of

shipment with correct storage (in a dry, cool $(5-25\ ^{\circ}\text{C})$ and dark place with container

tightly shut).

Processing

1) Spatulate well prior to processing.

When stored in a refrigerator, the paste should have acquired room temperature before being opened, to avoid condensation.

- 2) Print through a 325 mesh stainless steel screen. Total thickness: approx. 75 µm.
- 3) Level at room temperature for 5 10 minutes.
- 4) Dry at 150 °C for 10 20 minutes.
- 5) Fire at 850 °C (peak) for 10 minutes, and with a total firing cycle time of c. 30 60 minutes.

Typical Properties (Fired)¹

Fired Film Thickness²

(FFT)

 $8.0-12.0~\mu m$

Line Definition

 $\geq 125 \; \mu m$

Resistivity²

 \leq 50 m Ω/\Box (FFT: 12 μ m)

Aged Adhesion

(Sn96/Ag3.5/Cu0.5)

 \geq 20 N (48 hrs, 150 °C)

Leach Resistance (Sn96/Ag3.5/Cu0.5)

 \geq 4 dips (245 °C, 5 sec each)

Thinner

HVS 507



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Legend:

- Typical properties based on laboratory test methods. For optimum results all materials should be fired in a profiled furnace supplied with dried, hydrocarbon and other contaminant free air (PP-1).
- $^{2)}$ Measured after printing with a 325 mesh steel screen; screen thickness and emulsion thickness combined was c. 75 $\mu m,$ and the resultant printed track was 500 μm wide.
- * See the data sheet issue date (DD/MM/YY) as reference of validity of latest edition which is available on request

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